Ref#	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
Li Si	2338	(257/E23:037):CCLS. (257/676).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; ; IBM_TDB US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR OR	OFF OFF	2006/02/09 11:50
S2	1958	S1 and (@ad<"20010815" @rlad<"20010815")	; IBM_TDB US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT : IBM_TDB	OR	ON	2006/02/08 10:03
S3		S2 and (chip die) near2 (bond\$3 mount\$3) near3 (flag pad) with (coplanar co adj planar)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/02/06 12:37
S4	678	S2 and (chip die) near2 (bond\$3 mount\$3) near3 (flag pad)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ÖN	2006/02/06 12:40
S5	372	S2 and (chip die) near2 (bond\$3 mount\$3) near3 (flag pad) and (tape TAB)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/02/06 15:11
S6	53	(chip die) near2 (bond\$3 mount\$3) near3 (flag pad) same (coplanar co adj planar) and (tape TAB)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/02/09 11:40
S7	38	S6 not S5	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/02/06 15:11
S8	1804	(257/690) CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	OFF	2006/02/06 15:11
S9	180	S8 and (chip die) near2 (bond\$3 mount\$3) near3 (flag pad) and (tape TAB)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/02/09 11:39
S10	141	S9 and (@ad<"20010815", @rlad<"20010815")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/02/06:15:12

S11	110	S10 not (S6 S5)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/06 15:12
S12	2278	(chip die) near2: (bond\$3 mouni\$3) near3 (flag pad) same (tape TAB)	; IBM_TDB US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/06 17:11
S13	368	(257/672).CCLS.	; IBM_TDB US-PGPUB; USPAT; USOCR; EPO; JPO;	OR	OFF	2006/02/07 16:26
S14	315	S13 and (@ad<"20010815" @rlad<"20010815")	DERWENT; IBM_TDB; US-PGPUB; USPAT; USOCR; EPO; IPO;	OR	ON	2006/02/07:18:23
S15	14	. 09/742366	DERWENT ;IBM_TDB US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/07 18:20
S16	339	(tape adj automated adj bonding) and (pad flag) near3 (chip die) near2 mount\$3	; IBM_TDB US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/02/07 18:21
S17	293	S16 and (@ad<"20010815" @rlad<"20010815")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/08 09:33
S24	953	(257/707).CCLS.	; IBM_TDB US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2006/02/08 10:03
S25	686	S24 and (@ad<"20010815" @rlad<"20010815")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/08 10:03
S26	10	S25 and reel adj2 reel	; IBM_TDB US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/08 10:04
S27	188	S25 and tape	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/08 11:33
S28	840	(257/675).CCLS.	; IBM_TDB US-POPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	OFF	2006/02/08:11:33

S29	2	("5594234").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	OFF	2006/02/08 16:30
S31	7	reel adj to adj reel adj tape	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/02/08 16:31
S32	503	((chip die) near2 (bond\$3 mount\$3) near3 (flag pad) and (tape TAB)).clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/02/09 11:40
S33	.5	((chip die) near2 (bond\$3 mount\$3) near3 (flag pad) same (coplanar co adj planar) and (tape TAB)) clm	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM TDB	OR	ON	2006/02/09 11:40